NCE40TH60BP

600V, 40A, Trench FS II Fast IGBT

General Description:

Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSIIIGBT offers superior conduction and switching performances, and easy parallel operation;

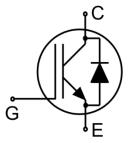
Features

Trench FSII Technology offering

- Very low V_{CE (sat)}
- High speed switching
- Positive temperature coefficient in V_{CE} (sat)
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE40TH60BP	TO-3P	NCE40TH60BP



TO-3P

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	600	V
V_{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	80	А
lc	Collector Current @T _C = 100 °C	40	А
I _{Cplus}	Pulsed Collector Current, tp limited by Tjmax	120	А
-	turn off safe operating area, VCE=600V, Tj=150°C	120	А
I _F	Diode Continuous Forward Current @T _C = 100 °C	30	А
I _{FM}	Diode Maximum Forward Current	90	А
Б	Power Dissipation @ T _C = 25°C	286	W
P _D	Power Dissipation @T _C = 100 °C	114	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +150	°C
TL	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V_{GE} =15.0V, $V_{\text{CC}} \le 400\text{V}$, Allowed number of short circuits<1000Time between short circuits: $\ge 1.0\text{s}$, $T_{j} \le 150^{\circ}\text{C}$	3	us



Thermal Characteristic

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	0.44	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	2.12	°C/W
RθJA	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

Cumbal	Dovernator	Test Conditions		Value				
Symbol	Parameter			Min.	Тур.	Max.	Units	
STATIC Cha	racteristics			•				
V _{(BR)CES}	Collector-EmitterBreakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V	
Ices	Collector-Emitter Leakage Current	V _{GE} =0V,	Vce=600V			4	uA	
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,Vce=0V			200	nA	
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30	V,Vce =0V			200	nA	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =40A	Tj=25°C		1.7	1.9	V	
V CE(sat)	Collector-Entitler Saturation Voltage	V _{GE} =15V	Tj=150°C		1.9		V	
$V_{\text{GE(th)}}$	Gate Threshold Voltage	Ic=1mA	,Vce=Vge	4.0	5.0	6.0	V	
Dynamic Cha	aracteristics							
Cies	Input Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			4894		pF	
Coes	Output Capacitance				136			
Cres	Reverse Transfer Capacitance				94			
Qg	Total Gate Charge	V _{CC} =480V, I _C =40A V _{GE} =15V			176		nC	
Qge	Gate to Emitter Charge				38		nC	
Q _{gc}	Gate to Collector Charge				73		nC	
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s				250		А	
Switching Cl	naracteristics							
$t_{d(ON)}$	Turn-on Delay Time				19			
t _r	Rise Time	$V_{CE}=400V,I_{C}=40A$ $V_{GE}=0/15V,R_{g}=5\Omega$			17		ne	
$t_{\text{d(OFF)}}$	Turn-Off Delay Time				168		ns	
t _f	Fall Time				16			
Eon	Turn-On Switching Loss	Inductive Load			0.58			
E _{off}	Turn-Off Switching Loss				0.48		mJ	
Ets	Total Switching Loss				1.06			

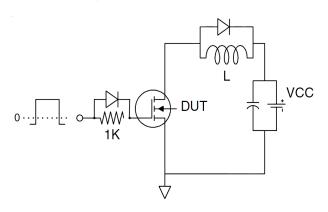
Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified):

Symbol	Parameter	Took Conditions	Rating			Units
		Test Conditions	Min.	Тур.	Max.	Units
V_{FM}	Diode Forward Voltage	I _F =30A		1.65	2.0	V
Trr	Reverse Recovery Time	Vac 400V I 20A		170		ns
I _{RRM}	Diode Peak Reverse Recovery Current	Vcc=400V, I _F =30A, di/dt=200A/uS		6.5		А
Qrr	Reverse Recovery Charge	ui/dl=200A/uS		0.7		uC
Pulse width $t_p \le 380 \mu s, \delta \le 2\%$						

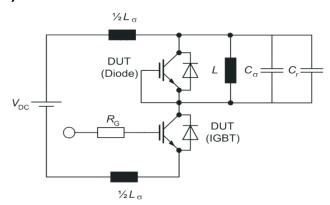


Test Circuit

1) Gate Charge Test Circuit

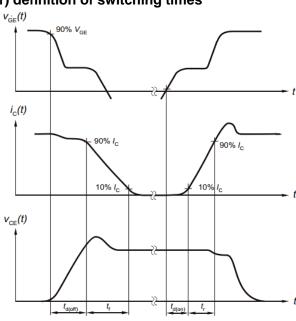


2) Switch Time Test Circuit

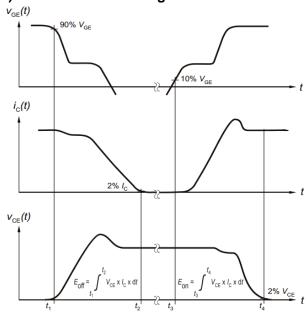


Switching characteristics

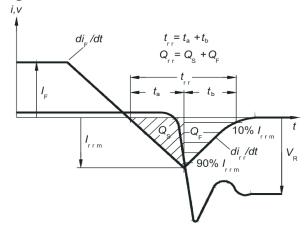
1) definition of switching times



2) definition of switching losses



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

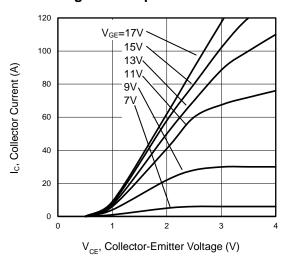


Figure 3 V_{CEsat} vs. Case Temperature

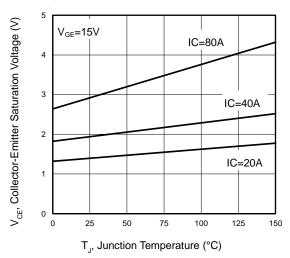


Figure 5 Capacitance Characteristics

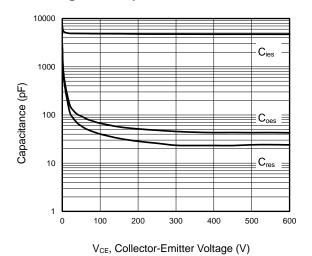


Figure 2 Transfer Characteristics

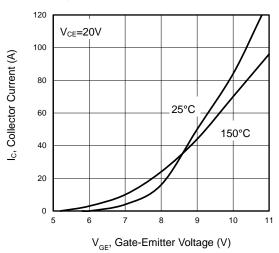


Figure 4 Saturation Voltage vs. V_{GE}

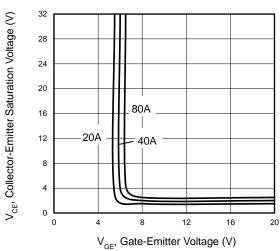
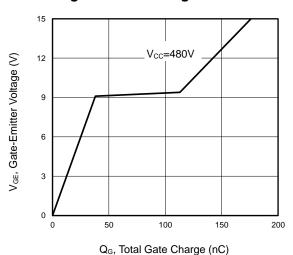


Figure 6 Gate charge waveform





Typical Electrical and Thermal Characteristics

Figure 7 Forward Characteristics

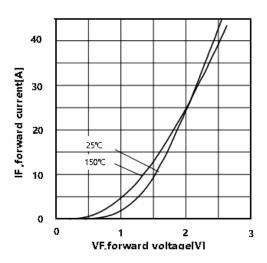


Figure 9 Typical Switching Times as a Function of Gate Resistor

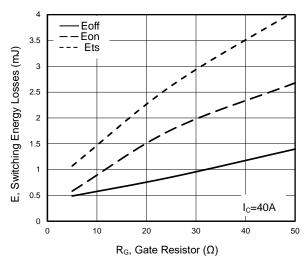


Figure 11 Gate-emitter Threshold Voltage as a Function of Junction Temperature

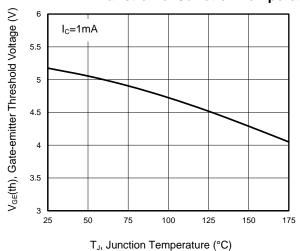


Figure 8 V_F vs. temperature

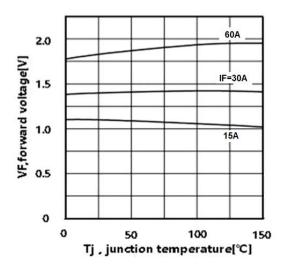


Figure 10 Typical Switching Times as a Function of Junction Temperature

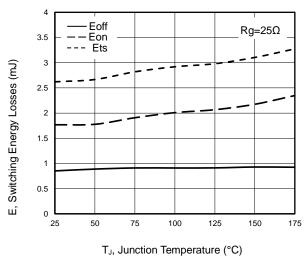
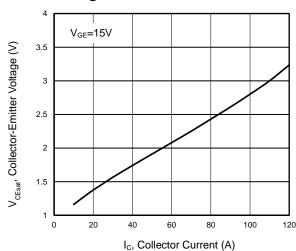
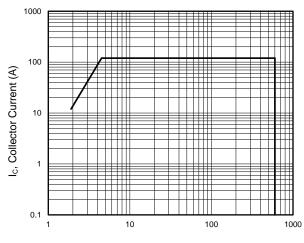


Figure 12 Typical Collector-emitter Saturation
Voltage as a function of Collector Current



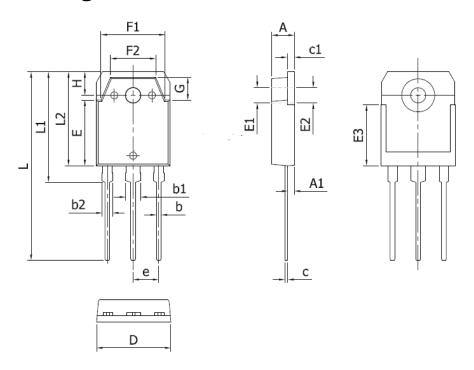
Typical Electrical and Thermal Characteristics

Figure 13 Forward Bias Safe Operating Area





TO-3P-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.60	5.00	0.18	0.20	
A1	1.20	1.60	0.05	0.06	
b	0.80	1.20	0.03	0.05	
b1	2.80	3.20	0.11	0.13	
b2	1.80	2.20	0.07	0.09	
С	0.50	0.70	0.02	0.03	
c1	1.45	1.65	0.06	0.06	
D	15.45	15.85	0.61	0.62	
E	13.70	14.10	0.54	0.56	
E1	3.30	REF	0.13 REF		
E2	3.20 REF		0.13 REF		
F1	13.40	13.80	0.53	0.54	
F2	9.40	9.80	0.37	0.39	
L	39.70	40.10	1.56	1.58	
L1	23.20	23.60	0.91	0.93	
L2	19.70	20.10	0.78	0.79	
G	4.60	5.00	0.18	0.20	
е	5.45	5.45 TYP. 0.21 TYP.			
Н	5.00	REF	0.20 REF		





NCE40TH60BP

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